


PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCN No.	AMG/17/10453	
1.3 Title of PCN	Assembly & Test in TSHT plant for selected products in SO8 packages	
1.4 Product Category	Selected products in SO8 package (see attached list)	
1.5 Issue date	2017-09-26	

2. PCN Team

2.1 Contact supplier	
2.1.1 Name	ROBERTSON HEATHER
2.1.2 Phone	+1 8475853058
2.1.3 Email	heather.robertson@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Lorenzo NASO
2.1.2 Marketing Manager	Marcello SAN BIAGIO
2.1.3 Quality Manager	Jean-Marc BUGNARD

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Transfer	Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Assembly site (SOP 2617)	Subcontractor TSHT

4. Description of change

	Old	New
4.1 Description	Assembly & Test plant = ST Bouskoura Subcontractor ASE Shanghai Subcontractor TFME	Assembly & Test plant = ST Bouskoura Subcontractor ASE Shanghai Subcontractor TFME Subcontractor TSHT
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No impact	

5. Reason / motivation for change

5.1 Motivation	Progressing on activities related to process modernization and quality improvement, ST is pleased to announce the introduction of TSHT/China as an added subcontractor for Assy and Test & Finishing activities for some products assembled in our SO8 package.
5.2 Customer Benefit	CAPACITY INCREASE

6. Marking of parts / traceability of change

6.1 Description	Finished good codes
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7. Timing / schedule

7.1 Date of qualification results	2017-10-16
7.2 Intended start of delivery	2017-12-25
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description			
8.2 Qualification report and qualification results	In progress	Issue Date	

9. Attachments (additional documentations)

10453 Public product.pdf
10453 PCN SO8_18Sep2017_.pdf

10. Affected parts

10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	LM158DT	
	LM193DT	
LM258DT	LM258DT	
LM2903DT	LM2903DT	
LM2904D	LM2904D	
LM2904DT	LM2904DT	
LM293DT	LM293DT	
LM358D	LM358D	
LM358DT	LM358DT	
LM393D	LM393D	
LM393DT	LM393DT	
	LM258WDT	
	LM2903WDT	
LM2904WDT	LM2904WDT	

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